

設備名稱：充電基座

型號 (型式) : CCB-H-010BT-BF

Equipment name

Type designation (Type)

單元Unit

限用物質及其化學符號

Restricted substances and its chemical symbols

鉛Lead
(Pb)

汞Mercury
(Hg)

鎘Cadmium
(Cd)

六價鉻Hexavalent
chromium
(Cr+6)

多溴聯苯Polybromi
nated biphenyls
(PBB)

多溴二苯醚Polybrominat
ed diphenyl ethers
(PBDE)

印刷電路部件 (PCB)

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○

○

○

○

○

上蓋 (Top Cover)

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○

○

○

○

○

下蓋 (Bottom Cover)

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○

○

○

○

○

連線 (配件)
(Cables)

○

○

○

○

○

○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。

Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

